



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Mail Stop: ISSUE FEE

Akihisa HONGO et al.

Confirmation No. 6855

Serial No. 10/017,384

Group Art Unit 1742

Filed December 18, 2001

Examiner Donald R. Valentine

SUBSTRATE PLATING METHOD AND APPARATUS

## **AMENDMENT UNDER 37 CFR 1.312**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Pursuant to the allowance for the above-referenced U.S. patent application, kindly amend the application as follows: